

# NPN SILICON RF POWER TRANSISTOR

**DESCRIPTION:**

The **ASI MLN2030F** is Designed for

**FEATURES:**

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- **Omnigold™** Metalization System

**MAXIMUM RATINGS**

<b>I<sub>C</sub></b>	500 mA
<b>V<sub>CE</sub></b>	20 V
<b>P<sub>DISS</sub></b>	--- W
<b>T<sub>J</sub></b>	-65 °C to +200 °C
<b>T<sub>STG</sub></b>	-65 °C to +200 °C
<b>θ<sub>JC</sub></b>	17.0 °C/W

**PACKAGE STYLE .250 2L FLG**

DIM	MINIMUM inches / mm	MAXIMUM inches / mm
A	.028 / 0.71	.032 / 0.81
B	.740 / 18.80	
C	.245 / 6.22	.255 / 6.48
D	.128 / 3.25	.132 / 3.35
E	.125 / 3.18	
F	.110 / 2.79	.117 / 2.97
G	.117 / 2.97	
H	.560 / 14.22	.570 / 14.48
I	.790 / 20.07	.810 / 20.57
J	.225 / 5.72	.235 / 5.97
K	.165 / 4.19	.185 / 4.70
L	.003 / 0.08	.007 / 0.18
M	.058 / 1.47	.068 / 1.73
N	.119 / 3.02	.135 / 3.43
P	.149 / 3.78	.187 / 4.75

**ORDER CODE: ASI10632**

**CHARACTERISTICS**  $T_C = 25\text{ }^\circ\text{C}$ 

SYMBOL	TEST CONDITIONS		MINIMUM	TYPICAL	MAXIMUM	UNITS
<b>BV<sub>CBO</sub></b>	$I_C = 1\text{ mA}$		50			<b>V</b>
<b>BV<sub>CEO</sub></b>	$I_C = 5\text{ mA}$		20			<b>V</b>
<b>BV<sub>EBO</sub></b>	$I_E = 1\text{ mA}$		3.5			<b>V</b>
<b>I<sub>CEO</sub></b>	$V_{CE} = 18\text{ V}$				1.0	<b>mA</b>
<b>h<sub>FE</sub></b>	$V_{CE} = 5.0\text{ V}$	$I_C = \text{mA}$	15		120	<b>---</b>
<b>C<sub>OB</sub></b>	$V_{CB} = 28\text{ V}$	$f = 1.0\text{ MHz}$			5.0	<b>pF</b>
<b>P<sub>G</sub></b>	$V_{CE} = 18\text{ V}$ $I_{CQ} = 220\text{ mA}$	$P_{OUT} = 1.0\text{ W}$ $f = 2.0\text{ GHz}$	7.0			<b>dB</b>